506695078 06/02/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

SUBMISSION TYPE: CORRECTIVE ASSIGNMENT **NATURE OF CONVEYANCE:** Corrective Assignment to correct the COVER SHEET previously recorded

on Reel 056012 Frame 0103. Assignor(s) hereby confirms the THE THIRD INVENTOR KEITH ALAN BOWMAN DATED THE ASSIGNMENT 07/22/2020 NOT 07/20/2020.

EPAS ID: PAT6741896

CONVEYING PARTY DATA

Name	Execution Date
BHARAT BHARAT RANGARAJAN	08/12/2020
DIPTI RANJAN PAL	12/16/2020
KEITH ALAN BOWMAN	07/22/2020
SRINIVAS TURAGA	09/10/2020
ATEESH DEEPANKAR DE	08/20/2020
SHIH-HSIN JASON HU	07/27/2020
CHANDAN AGARWALLA	04/18/2021

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16874538

CORRESPONDENCE DATA

Fax Number: (310)201-5219

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 310.277.7200

Email: Qualcomm-USPTO@seyfarth.com

SEYFARTH SHAW LLP **Correspondent Name:**

Address Line 1: 2029 CENTURY PARK EAST, SUITE 3500

LOS ANGELES, CALIFORNIA 90067 Address Line 4:

ATTORNEY DOCKET NUMBER: 200941

JOSEPH LUTZ NAME OF SUBMITTER:

SIGNATURE:	/Joseph Lutz/		
DATE SIGNED:	06/02/2021		
Total Attachments: 10			
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PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6671734

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
BHARAT KUMAR RANGARAJAN	08/12/2020
DIPTI RANJAN PAL	12/16/2020
KEITH ALAN BOWMAN	07/20/2020
SRINIVAS TURAGA	09/10/2020
ATEESH DEEPANKAR DE	08/20/2020
SHIH-HSIN JASON HU	07/27/2020
CHANDAN AGARWALLA	04/18/2021

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16874538

CORRESPONDENCE DATA

Fax Number: (310)201-5219

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using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 310.277.7200

Email: Qualcomm-USPTO@seyfarth.com

Correspondent Name: SEYFARTH SHAW LLP

2029 CENTURY PARK EAST, SUITE 3500 Address Line 1:

LOS ANGELES, CALIFORNIA 90067 Address Line 4:

ATTORNEY DOCKET NUMBER:	200941
NAME OF SUBMITTER:	JOSEPH LUTZ
SIGNATURE:	/Joseph Lutz/
DATE SIGNED:	04/22/2021

ASSIGNMENT

WHEREAS, WE.

- 1. Bharat Kumar RANGARAJAN, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714,
- 2. Dipti Ranjan PAL, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714,
- 3. Keith Alan BOWMAN, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714,
- 4. Srinivas TURAGA, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714,
- 5. Ateesh Deepankar DE, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714,
- 6. Shih-Hsin Jason HU, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714,
- 7. Chandan AGARWALLA, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to ON-DIE VOLTAGE-FREQUENCY SECURITY MONITOR (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 16/874,538, filed on May 14, 2020, Qualcomm Reference Number

200941, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

Done at	BANGALLA	on 8/12/2020 Date	Bharat Kumar RANGARAJAN
	City, State	Date	Bharat Kumar RANGARAJAN
Done at	City, State	on Date	Dipti Ranjan PAL
Done at	, (o n	
•	City, State	On Date	Keith Alan BOWMAN
Done at	City, State	on Date	Srinivas TURAGA
Done at	, City, State	on	
			Ateesh Deepankar DE
Done at	City, State	on	Shih-Hsin Jason HU
	City, State	Date	Chandan AGARWALLA

PATENT

Qualcomm Reference Number: 200941

Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	, on	
City, State	, on	Bharat Kumar RANGARAJAN
Done at <u>YVIA®, cA</u> City, State	, on	Dipti Ranjan PAL
Done at	, on	Keith Alan BOWMAN
Done at	, on Date	
City, State	Date	Srinivas TURAGA
Done at	on	
City, State	Date	Ateesh Deepankar DE
Done at	, on	
City, State	Date	Shih-Hsin Jason HU
Done at	on	
City, State	Date	Chandan AGARWALLA

Done at _		on	
	City, State	On	Bharat Kumar RANGARAJAN
Done at _	City State	on	Dipti Ranjan PAL
none at 1	City, State	on <u>7/m3/3030</u> Date	Keith Alan BOWMAN
Done at _	City, State	on	Srinivas TURAGA
Done at _	City, State	on	Ateesh Deepankar DE
			Shih-Hsin Jason HU
			Chandan AGARWALLA
***	City, State	Date	Chandan AGARWALLA

Done at		on	
	City, State	Date	Bharat Kumar RANGARAJAN
Done at		on	Dipti Ranjan PAL
	City, State	Date	Dipti Ranjan PAL
Done at		on	Keith Alan BOWMAN
	City, State	Date	Keith Alan BOWMAN
Done at	Berd han kin	on Sep 1000, 2020	Srinivas TURAGA
Done at	City, State	Date	Srinivas TURAGA
Done at		on	Ateesh Deepankar DE
***	City, State	Date	Ateesh Deepankar DE
Done at	,	on	
<u></u>	City, State	On Date	Shih-Hsin Jason HU
Done at	_	on	
rane at "	City, State	on Date	Chandan AGARWALLA

			Trate:	Digit Raman PA
Park 18	No. Sept		Costs	Keets Assis NOWNAN
Pencil.	Con State	- 10 m	Cons	Smar L. RAGA
Pere s				Alexandra Acquirida Acquir
	Car State		Date	Shift Ham Jacob Hill
Per a	Try New	.08	- Date	Change ACARWALLA

PATENT

REEL: 056461 FRAME: 0725

Done at _	, on		
	City, State	Date	Bharat Kumar RANGARAJAN
Done at _	, on		
	City, State	Date	Dipti Ranjan PAL
Done at _	, on		
	City, State	Date	Keith Alan BOWMAN
Done at _	, on		
	City, State	Date	Srinivas TURAGA
Done at _	, on		
			Ateesh Deepankar DE
Done at	San Diego, CA on City, State	7/27/2020	Shih Boon an
	City, State	Date	Shih-Hsin Jason HU
Done at _	, on		Chandan AGARWALLA
	City, State	Date	Chandan A(†ARWALLA

Done at		, on	
	City, State	Date	Bharat Kumar RANGARAJAN
Done at _		on Date	
	City, State	Date	Dipti Ranjan PAL
Done at _		, ón	Keith Alan BOWMAN
	City, State	Date	Keith Alan BOWMAN
Done at _		, 00	Sriniyas TURAGA
	City, State	Date	Srinivas TURAGA
Done at _		_, on	
	City, State	Date	Ateesh Deepankar DE
Done at _		., on	
	City, State	Date	Shih-Hsin Jason HU
Done at _	SAN DIEGO,	_, on	Chandan AGARWALLA
	City, State	Date	Chandan AGARWALLA

PATENT REEL: 056461 FRAME: 0727

RECORDED: 06/02/2021